

# Off-Line Quasi-Resonant Switching Regulators

## Features and Benefits

- Quasi-resonant topology IC  $\Rightarrow$  Low EMI noise and soft switching
- Bottom-skip mode  $\Rightarrow$  Improved system efficiency over the entire output load by avoiding increase of switching frequency
- Auto-Standby mode  $\Rightarrow$  Lowers input power at very light output load condition
- Avalanche-guaranteed MOSFET  $\Rightarrow$  Improves system-level reliability and does not require  $V_{DSS}$  derating
- $800 V_{DSS} / 0.66 \Omega R_{DS(on)}$
- Various protections  $\Rightarrow$  Improved system-level reliability
  - Pulse-by-pulse drain overcurrent limiting
  - Overvoltage Protection (bias winding voltage sensing), with latch
  - Overload Protection with latch
  - Maximum on-time limit

## Package: 7-Pin TO-3P



Not to scale

## Description

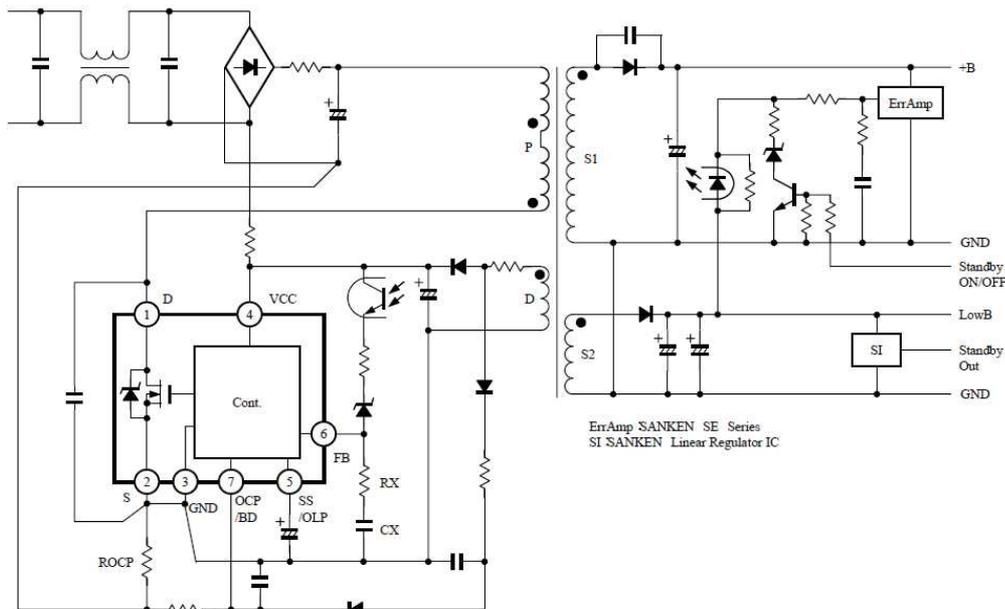
The STR-X6769 is a quasi-resonant topology IC designed for SMPS applications. It shows lower EMI noise characteristics than conventional PWM solutions, especially at greater than 2 MHz. It also provides a soft-switching mode to turn on the internal MOSFET at close to zero voltage ( $V_{DS}$  bottom point) by use of the resonant characteristic of primary inductance and a resonant capacitor.

The package is a fully molded TO-3P, which contains the controller chip (MIC) and MOSFET, enabling output power up to 310 W at 230 VAC and 200 W at universal input. The bottom-skip mode skips the first bottom of  $V_{DS}$  and turns on the MOSFET at the second bottom point, to minimize an increase of operating frequency at light output load, improving system-level efficiency over the entire load range.

There are two standby functions available to reduce the input power under very light load conditions. The first is Auto-Standby mode, which is internally triggered by periodic sensing, and the other is a manual standby mode, which is executed by clamping the secondary output. In general applications, the manual standby mode reduces the input power further compared to Auto-Standby mode.

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## Typical Application



**Description (continued)**

The soft-start mode minimizes surge voltage and reduces power stress to the MOSFET and to the secondary rectifying diodes during the start-up sequence. Various protections such as overvoltage, overload, overcurrent, maximum on-time protections and avalanche-energy-guaranteed MOSFET secure good system-level reliability.

Applications include the following:

- Set Top Box
- LCD PC monitor, LCD TV
- Printer, Scanner
- SMPS power supplies

**Selection Guide**

Part Number	Package
STR-X6769	TO-3P

**Absolute Maximum Ratings at  $T_A = 25^\circ\text{C}$** 

Parameter	Symbol	Conditions	Rating	Unit
Drain Current <sup>1</sup>	$I_{Dpeak}$	Single pulse	22	A
Maximum Switching Current <sup>2</sup>	$I_{Dmax}$	$T_A = -20^\circ\text{C}$ to $125^\circ\text{C}$	22	A
Single Pulse Avalanche Energy <sup>3</sup>	$E_{AS}$	Single pulse, $V_{DD} = 30\text{ V}$ , $L = 50\text{ mH}$ , $I_{Lpeak} = 3.9\text{ A}$	395	mJ
Input Voltage for Controller (MIC)	$V_{CC}$		35	V
SS/OLP Terminal Voltage	$V_{SSOLP}$		-0.5 to 6.0	V
FB Terminal Inflow Current	$I_{FB}$		10	mA
FB Terminal Voltage	$V_{FB}$	$I_{FB}$ within the limits of $I_{FB}$	-0.5 to 9.0	V
OCP/BD Terminal Voltage	$V_{OCPBD}$		-1.5 to 5.0	V
MOSFET Power Dissipation <sup>4</sup>	$P_{D1}$	With infinite heatsink	46	W
		Without heatsink	2.8	W
Controller (MIC) Power Dissipation	$P_{D2}$	$V_{CC} \times I_{CC}$	0.8	W
Operating Internal Leadframe Temperature	$T_F$	Recommended operation temperature, see cautions	-20 to 125	$^\circ\text{C}$
Operating Ambient Temperature	$T_{OP}$		-20 to 125	$^\circ\text{C}$
Storage Temperature	$T_{stg}$		-40 to 125	$^\circ\text{C}$
Channel Temperature	$T_{ch}$		150	$^\circ\text{C}$

<sup>1</sup>Refer to MOSFET ASO curve

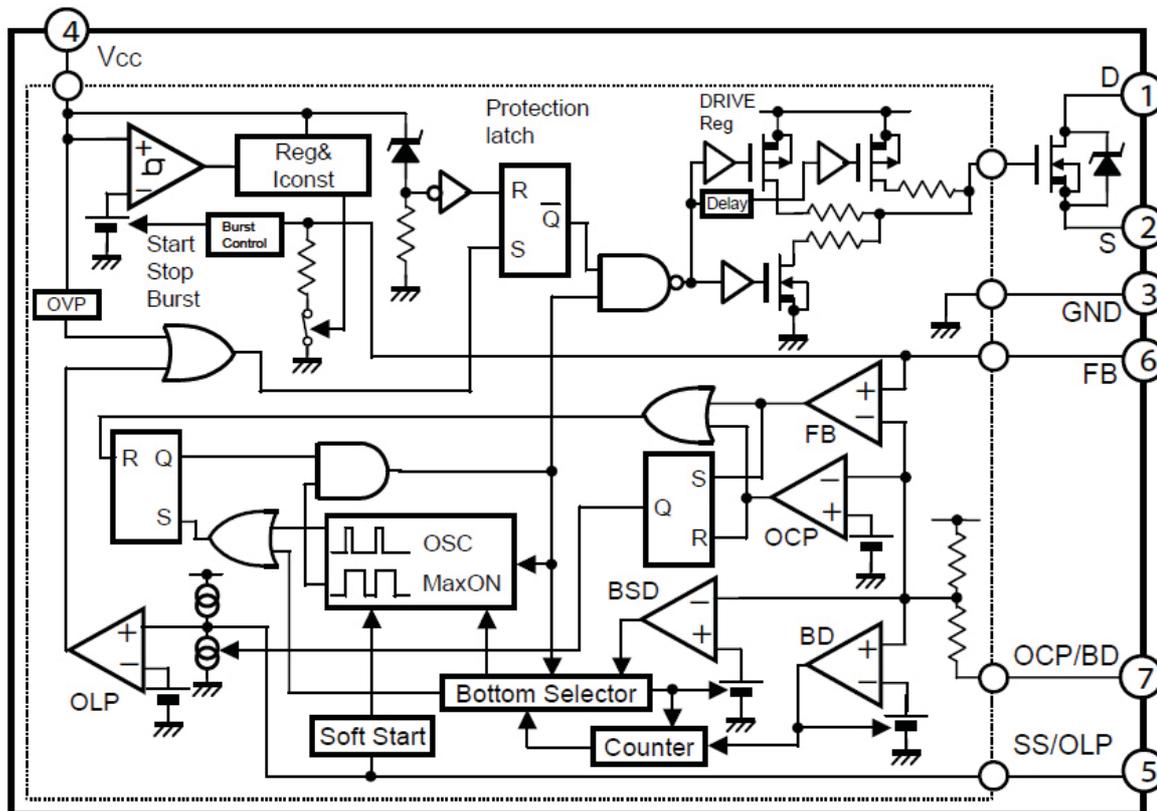
<sup>2</sup> $I_{DMAX}$  is the drain current determined by the drive voltage of the IC and the threshold voltage,  $V_{th}$ , of the MOSFET

<sup>3</sup>Refer to Avalanche Energy Derating curve

<sup>4</sup>Refer to MOSFET Ta-PD1 curve

All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature,  $T_A$ , of  $25^\circ\text{C}$ , unless otherwise stated.

Functional Block Diagram



Terminal List Table

Number	Name	Description	Functions
1	D	Drain	MOSFET drain
2	S	Source	MOSFET source
3	GND	Ground terminal	Ground
4	VCC	Power supply terminal	Input of power supply for control circuit
5	SS/OLP	Soft Start/Overload Protection terminal	Input to set delay for Overload Protection and Soft Start operation
6	FB	Feedback terminal	Input for Constant Voltage Control and Burst (intermittent) Mode oscillation control signals
7	OCP/BD	Overcurrent Protection/Bottom Detection	Input for Overcurrent Detection and Bottom Detection signals